



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



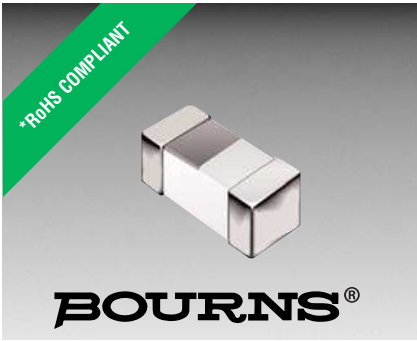
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Features

- 0402 size
- Available in E12 Series
- High frequency
- Nickel barrier
- RoHS compliant*

Applications

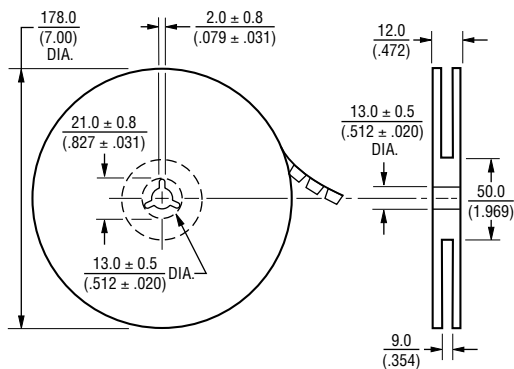
- Mobile phones
- Cellular phones
- CTV, VCR, HIC, FDD
- Automotive electronics

CI100505 Series - Multi-Layer Chip Inductors

Electrical Specifications

Bourns Part No.	Inductance @100 MHz		Q Typ.			SRF MHz		DCR	I rms
	nH	Tol. %	@100 MHz	@500 MHz	@1000 MHz	min.	typ.	ohm max.	mA max.
CI100505-1N0D	1.0	±0.3 nH	8	34	52	6000	13000	0.08	300
CI100505-1N2D	1.2	±0.3 nH	8	35	52	6000	10000	0.09	300
CI100505-1N5D	1.5	±0.3 nH	8	33	48	6000	10000	0.10	300
CI100505-1N8D	1.8	±0.3 nH	8	30	42	6000	9500	0.12	300
CI100505-2N2D	2.2	±0.3 nH	8	25	36	6000	9000	0.13	300
CI100505-2N7D	2.7	±0.3 nH	8	24	34	6000	9000	0.13	300
CI100505-3N3D	3.3	±0.3 nH	8	24	35	6000	8000	0.16	300
CI100505-3N9D	3.9	±0.3 nH	8	24	35	4000	6500	0.21	300
CI100505-4N7D	4.7	±0.3 nH	8	23	34	4000	5000	0.21	300
CI100505-5N6D	5.6	±0.3 nH	8	24	35	4000	5000	0.23	300
CI100505-6N8J	6.8	±5	8	23	32	3900	4400	0.25	300
CI100505-8N2J	8.2	±5	8	23	31	3600	4000	0.28	250
CI100505-10NJ	10	±5	8	23	31	3200	3500	0.31	250
CI100505-12NJ	12	±5	8	23	31	2700	3500	0.40	200
CI100505-15NJ	15	±5	8	23	30	2300	3000	0.46	200
CI100505-18NJ	18	±5	8	23	30	2100	2600	0.55	200
CI100505-22NJ	22	±5	8	22	27	1900	2200	0.60	200
CI100505-27NJ	27	±5	8	21	26	1600	1900	0.70	200
CI100505-33NJ	33	±5	8	20	22	1300	1700	0.80	200
CI100505-39NJ	39	±5	8	20	21	1200	1600	0.90	100
CI100505-47NJ	47	±5	8	19	18	1000	1300	1.00	100
CI100505-56NJ	56	±5	8	18	16	750	900	1.00	100
CI100505-68NJ	68	±5	8	17	11	700	800	1.20	100
CI100505-82NJ	82	±5	8	16	6	600	700	1.30	100
CI100505-R10J	100	±5	8	14	—	550	650	1.50	100

Packaging Specifications



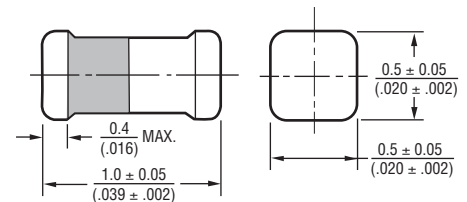
General Specifications

Temperature Rise20 °C max. at rated current
 Operating Temperature...-40 °C to +105 °C
 Storage Temperature...-40 °C to +105 °C
 Reflow Soldering ...230 °C, 50 sec. max.
 Resistance to Soldering Heat260 °C, 10 seconds

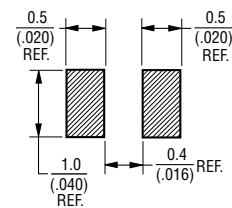
Materials

Base MaterialCeramic
 Terminal.....Ag/Ni/Sn
 Packaging.....10,000 pcs. per reel

Product Dimensions



Recommended Layout



DIMENSIONS: $\frac{\text{MM}}{\text{(INCHES)}}$

*RoHS Directive 2002/95/EC Jan. 27, 2003 including annex and RoHS Recast 2011/65/EU June 8, 2011.

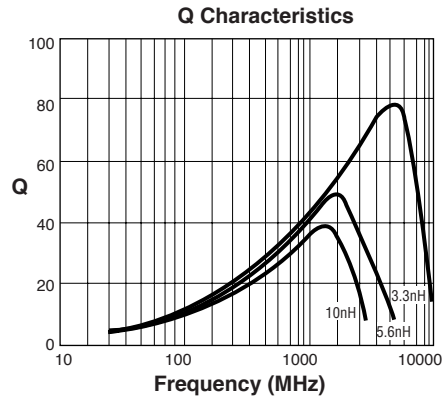
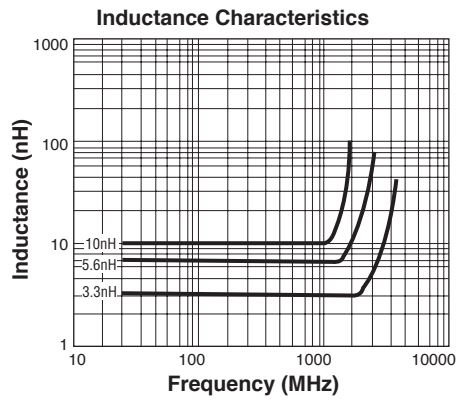
Specifications are subject to change without notice.

The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time. Users should verify actual device performance in their specific applications.

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Electrical Specifications



REV. 07/14

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